# US2881



#### Bipolar Hall Switch – Very High Sensitivity

#### **Features and Benefits**

- Wide operating voltage range from 3.5V to 24V
- Very high magnetic sensitivity
- CMOS technology
- Chopper-stabilized amplifier stage
- Low current consumption
- Open drain output
- Thin SOT23 3L and flat TO-92 3L both RoHS Compliant packages

## **Applications**

- Automotive, Consumer and Industrial
- Solid-state switch
- Brushless DC motor commutation
- Speed detection
- Linear position detection
- Angular position detection
- Proximity detection

## **Ordering information**

Product code	Temperature Code	Package Code	Option code	Packing form code
US2881	E	SE	AAA-000	RE
US2881	E	UA	AAA-000	BU
US2881	L	SE	AAA-000	RE
US2881	L	UA	AAA-000	BU

#### Legend:

Temperature code:	L(-40 to 150°C)
	E(-40 to 85°C)
Package Code:	SE = TSOT-23L
	UA = TO92-3L
Packing Form:	BU = Bulk
	RE = Reel
Ordering Example:	US2881ESE-AAA-000-RE

## **1. Functional Diagram**



## 2. General Description

The Melexis US2881 is a bipolar Hall-effect switch designed in mixed signal CMOS technology.

The device integrates a voltage regulator, Hall sensor with dynamic offset cancellation system, Schmitt trigger and an open-drain output driver, all in a single package.

Thanks to its wide operating voltage range and extended choice of temperature range, it is suitable for use in automotive and consumer applications.

The device is delivered in a Thin Small Outline Transistor (TSOT) for surface mount process and in a Plastic Single In Line (TO-92 flat) for through-hole mount.

Both 3-lead packages are RoHS compliant.



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## 3. Glossary of Terms

MilliTesla (mT), Gauss	Units of magnetic flux density:
	1mT = 10 Gauss
RoHS	Restriction of Hazardous Substances
TSOT	Thin Small Outline Transistor (TSOT package) – also referred with the Melexis package code "SE"
ESD	Electro-Static Discharge
BLDC	Brush-Less Direct-Current

# 4. Absolute Maximum Ratings

Parameter	Symbol	Value	Units
Supply Voltage	V <sub>DD</sub>	28	V
Supply Current	I <sub>DD</sub>	50	mA
Output Voltage	V <sub>OUT</sub>	28	V
Output Current	I <sub>OUT</sub>	50	mA
Storage Temperature Range	Ts	-50 to 150	°C
Maximum Junction Temperature	TJ	165	°C

Table 1: Absolute maximum ratings

Exceeding the absolute maximum ratings may cause permanent damage. Exposure to absolute-maximum- rated conditions for extended periods may affect device reliability.

Operating Temperature Range	Symbol	Value	Units
Temperature Suffix "E"	T <sub>A</sub>	-40 to 85	°C
Temperature Suffix "L"	T <sub>A</sub>	-40 to 150	°C

# **5. Pin Definitions and Descriptions**

SE Pin	No	UA Pin No	Name	Туре	Function
1		1	VDD	Supply	Supply Voltage pin
2		3	OUT	Output	Open Drain Output pin
3		2	GND	Ground	Ground pin

Table 2: Pin definitions and descriptions





SE package

UA package



# 6. General Electrical Specifications

#### DC Operating Parameters $T_A = 25^{\circ}$ C, $V_{DD} = 3.5$ V to 24V (unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Units
Supply Voltage	V <sub>DD</sub>	Operating	3.5	12	24	V
Supply Current	I <sub>DD</sub>	$B < B_{RP}$	1.1	2.6	5	mA
Output Saturation Voltage	V <sub>DSon</sub>	$I_{OUT} = 20 \text{mA}, \text{B} > B_{OP}$		0.11	0.5	V
Output Leakage Current	I <sub>OFF</sub>	$B < B_{RP}, V_{OUT} = 24V$		0.01	10	μΑ
Output Rise Time	t <sub>r</sub>	$R_L = 1k\Omega$ , $C_L = 20pF$		0.25		μs
Output Fall Time	t <sub>f</sub>	$R_L = 1k\Omega$ , $C_L = 20pF$		0.25		μs
Maximum Switching Frequency	F <sub>SW</sub>			10		kHz
SE Package Thermal Resistance	R <sub>TH</sub>	Single layer (1S) Jedec board		301		°C/W
UA Package Thermal Resistance	R <sub>TH</sub>			200		°C/W

Table 3: Electrical specifications

# 7. Magnetic Specifications

DC Operating Parameters  $V_{DD}$  = 3.5V to 24V (unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Units
Operating Point	B <sub>OP</sub>		0.5		4.5	mT
Release Point	B <sub>RP</sub>	T <sub>A</sub> = 25°C, E & L spec.	-4.5		-0.5	mT
Hysteresis	B <sub>HYST</sub>		1.5		6	mT
Operating Point	B <sub>OP</sub>		-1		6	mT
Release Point	B <sub>RP</sub>	T <sub>A</sub> = 85°C, E & L spec.	-6		1	mT
Hysteresis	B <sub>HYST</sub>		1.5		6	mT
Operating Point	B <sub>OP</sub>		-2		6	mT
Release Point	B <sub>RP</sub>	T <sub>A</sub> = 150°C, E & L spec.	-6		2	mT
Hysteresis	B <sub>HYST</sub>		1.5		6	mT

Table 4: Magnetic specifications

Note: For typical values, please refer to the performance graphs in section 11

## 8. Output Behaviour versus Magnetic Pole

DC Operating Parameters  $T_A = -40$  C to 150 C,  $V_{DD} = 3.5V$  to 24V (unless otherwise specified)

Parameter	Test Conditions (SE)	OUT (SE)	Test Conditions (UA)	OUT (UA)
South pole	B < B <sub>RP</sub>	High	$B > B_{OP}$	Low
North pole	$B > B_{OP}$	Low	B < B <sub>RP</sub>	High

Table 5: Output	behaviour versus	magnetic pole
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## 9. Detailed General Description

Based on mixed signal CMOS technology, Melexis US2881 is a Hall-effect device with very high magnetic sensitivity. It allows using generic magnets, weak magnets or larger air gap.

The chopper-stabilized amplifier uses switched capacitor technique to suppress the offset generally observed with Hall sensors and amplifiers. The CMOS technology makes this advanced technique possible and contributes to smaller chip size and lower current consumption than bipolar technology. The small chip size is also an important factor to minimize the effect of physical stress.

This combination results in more stable magnetic characteristics and enables faster and more precise design.

The wide operating voltage from 3.5V to 24V, "L" and "E" operating temperature range and low current consumption make this device especially suitable for automotive and BLDC motor applications.

The output signal is open-drain type. Such output allows simple connectivity with TTL or CMOS logic by using a pull-up resistor tied between a pull-up voltage and the device output.

## **10. Unique Features**

The US2881 exhibits bipolar magnetic switching characteristics. Therefore, it operates with both south and north poles.



Typically, the device behaves as a latch with symmetric operating and release switching points ( $B_{OP}$ =| $B_{RP}$ |). This means magnetic fields with equivalent strength and opposite direction drive the output high and low.

Removing the magnetic field ( $B\rightarrow 0$ ) keeps the output in its previous state. This latching property defines the device as a magnetic memory.

Depending on the magnetic switching points, the device may also behave as a unipolar positive switch ( $B_{OP}$  and  $B_{RP}$  strictly positive) or negative switch ( $B_{OP}$  and  $B_{RP}$  strictly negative). That is the output can be set high and low by only using one magnetic pole. In such case, removing the magnetic field changes the output level.



Unipolar positive switch characteristic

Unipolar negative switch characteristic

In latch, positive or negative switch behaviour, a magnetic hysteresis B<sub>HYST</sub> keeps B<sub>OP</sub> and B<sub>RP</sub> separated by a minimal value. This hysteresis prevents output oscillation near the switching point.



# **11. Performance Graphs**

## 11.1. Magnetic parameters vs. T<sub>A</sub>



11.3. V<sub>DSON</sub> vs. T<sub>A</sub>



11.5. I<sub>DD</sub> vs. T<sub>A</sub>



## 11.2. Magnetic parameters vs. $V_{DD}$



11.4. V<sub>DSON</sub> vs. V<sub>DD</sub>



11.6.  $I_{\text{DD}}$  vs.  $V_{\text{DD}}$ 





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#### 11.7. I<sub>OFF</sub> vs. T<sub>A</sub>

11.8. I<sub>OFF</sub> vs. V<sub>DD</sub>



## **12. Test Conditions**

Note: DUT = Device Under Test

#### 12.1. Supply Current



Note 1 - The supply current <sub>DD</sub> represents the static supply current. OUT is left open during measurement.

Note 2 - The device is put under magnetic field with  $B < B_{RP}$ .

#### 12.3. Output Leakage Current





#### 12.2. Output Saturation Voltage



Note 1 - The output saturation voltage V\_{DSon} is measured at  $\rm V_{DD}$  = 3.5V and  $\rm V_{DD}$  = 24V

Note 2 - The device is put under magnetic field with B>B\_OP.

#### 12.4. Magnetic Thresholds



- Note 1  $B_{_{\rm OP}}$  is determined by putting the device under magnetic field swept from  $E_{_{\rm RPmin}}$  up to  $B_{_{\rm OPmax}}$  until the output is switched on.
- Note 2 B<sub>RP</sub> is determined by putting the device under magnetic field swept from  $E_{_{\rm CPmax}}$  down to B\_{\_{\rm RPmin}} until the output is switched off.



## **13. Application Information**

## 13.1. Typical Three-Wire Application Circuit



## 13.3. Automotive and Harsh, Noisy Environments **Three-Wire Circuit**



13.2. Two-Wire Circuit



Note:

With this circuit, precise ON and OFF currents can be detected using only two connecting wires.

The resistors RL and Rb can be used to bias the input current. Refer to the part specifications for limiting values.

 $\begin{array}{ll} \mathsf{B}_{\mathsf{RP}}: & \mathsf{I}_{\mathsf{OFF}} = \mathsf{I}_{\mathsf{R}} + \mathsf{I}_{\mathsf{DD}} = \mathsf{V}_{\mathsf{DD}}/\mathsf{R}_{\mathsf{b}} + \mathsf{I}_{\mathsf{DD}} \\ \mathsf{B}_{\mathsf{OP}}: & \mathsf{I}_{\mathsf{ON}} = \mathsf{I}_{\mathsf{OFF}} + \mathsf{I}_{\mathsf{OUT}} = \mathsf{I}_{\mathsf{OFF}} + \mathsf{V}_{\mathsf{DD}}/\mathsf{R}_{\mathsf{L}} \end{array}$ 

# 14. Application Comments

For proper operation, a 100nF bypass capacitor should be placed as close as possible to the device between the V\_DD and ground pin.

For reverse voltage protection, it is recommended to connect a resistor or a diode in series with the V<sub>DD</sub> pin. When using a resistor, three points are important:

- the resistor has to limit the reverse current to 50mA maximum ( $V_{cc}$  / R1  $\leq$  50mA)
- the resulting device supply voltage  $V_{DD}$  has to be higher than  $V_{DD}$  min ( $V_{DD} = V_{CC} R1.I_{DD}$ ) the resistor has to withstand the power dissipated in reverse voltage condition ( $P_D = V_{CC}^2 / R1$ )
- When using a diode, a reverse current cannot flow and the voltage drop is almost constant ( $\approx 0.7$ V).

Therefore, a  $100\Omega/0.25W$  resistor for 5V application and a diode for higher supply voltage are recommended. Both solutions provide the required reverse voltage protection.

When a weak power supply is used or when the device is intended to be used in noisy environment, it is recommended that figure 13.3 from the Application Information section is used.

The low-pass filter formed by R1 and C1 and the zener diode Z1 bypass the disturbances or voltage spikes occurring on the device supply voltage V<sub>DD</sub>. The diode D1 provides additional reverse voltage protection.



# **15. Standard information regarding manufacturability of Melexis products** with different soldering processes

Our products are classified and qualified regarding soldering technology, solderability and moisture sensitivity level according to following test methods:

#### Reflow Soldering SMD's (Surface Mount Devices)

- IPC/JEDEC J-STD-020 Moisture/Reflow Sensitivity Classification for Nonhermetic Solid State Surface Mount Devices (classification reflow profiles according to table 5-2)
- EIA/JEDEC JESD22-A113 Preconditioning of Nonhermetic Surface Mount Devices Prior to Reliability Testing (reflow profiles according to table 2)

#### Wave Soldering SMD's (Surface Mount Devices) and THD's (Through Hole Devices)

- EN60749-20
- Resistance of plastic- encapsulated SMD's to combined effect of moisture and soldering heat
- EIA/JEDEC JESD22-B106 and EN60749-15 Resistance to soldering temperature for through-hole mounted devices

#### Iron Soldering THD's (Through Hole Devices)

 EN60749-15 Resistance to soldering temperature for through-hole mounted devices

#### Solderability SMD's (Surface Mount Devices) and THD's (Through Hole Devices)

• EIA/JEDEC JESD22-B102 and EN60749-21 Solderability

For all soldering technologies deviating from above mentioned standard conditions (regarding peak temperature, temperature gradient, temperature profile etc) additional classification and qualification tests have to be agreed upon with Melexis.

The application of Wave Soldering for SMD's is allowed only after consulting Melexis regarding assurance of adhesive strength between device and board.

Melexis is contributing to global environmental conservation by promoting **lead free** solutions. For more information on qualifications of **RoHS** compliant products (RoHS = European directive on the Restriction Of the use of certain Hazardous Substances) please visit the quality page on our website: <u>http://www.melexis.com/quality.aspx</u>

### **16. ESD Precautions**

Electronic semiconductor products are sensitive to Electro Static Discharge (ESD). Always observe Electro Static Discharge control procedures whenever handling semiconductor products.



# **17.** Package Information

## 17.1. SE Package (TSOT-3L)



This table in mm

	Α	A1	A2	D	Ε	E1	L	b	С	е	e1	α
min	-	0.025	0.85	2.80	2.60	1.50	0.30	0.30	0.10	0.95	1.90	0°
max	1.00	0.10	0.90	3.00	3.00	1.70	0.50	0.45	0.20	BSC	BSC	8°



## 17.2. UA Package (TO-92 flat)



#### Notes:

- 1. Mold flashes and protrusion are not included.
- 2. Gate burrs shall not exceed 0.127mm on the top side.

### Hall plate location





#### Notes:

1. All dimensions are in millimeters

#### Marking:

1st Line : U28 - Part number (US2881)

2<sup>nd</sup> Line : yww

y - last digit of year ww - calendar week

#### This table in mm

	Α	D	Ε	F	J	L	L1	S	<b>b1</b>	<b>b2</b>	С	е	e1
min	2.80	3.90	1.40	0.00	2.51	14.0	1.55	0.63	0.35	0.43	0.35	2.51	1.24
max	3.20	4.30	1.60	0.20	2.72	15.0	1.75	0.84	0.44	0.52	0.44	2.57	1.30
	θ1	θ2	θ3	θ4									
min	5°	5°	45°	3°									
max	MAX	REF	REF	REF									



## **18. Contact**

For the latest version of this document, go to our website at www.melexis.com.

For additional information, please contact our Direct Sales team and get help for your specific needs:

Europe, Africa	Telephone: +32 13 67 04 95			
	Email : sales_europe@melexis.com			
Americas	Telephone: +1 603 223 2362			
	Email : sales_usa@melexis.com			
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